## 508022967 07/21/2023 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT	
CONVEYING PARTY	ΟΑΤΑ			
		Name	Execution Date	
MOLEX JAPAN, LLC			10/15/2020	
RECEIVING PARTY D	ΑΤΑ			
Name:	MOLE	MOLEX, LLC		
Street Address:	2222 V	2222 WELLINGTON COURT		
City:	LISLE	LISLE		
State/Country:	ILLINC	ILLINOIS		
Postal Code:	60532	60532		
Property Type Application Number:		Number 17391359		
<i>using a fax number, it</i> Phone: Email: Correspondent Name	be sent to f provideo	o the e-mail address first; if that is u d; if that is unsuccessful, it will be s 630-718-5534 Paralegal_koch@CPAGlobal.com MOLEX, LLC		
		2222 WELLINGTON COURT LISLE, ILLINOIS 60532		
ATTORNEY DOCKET NUMBER:		MX-2020-PAT-0124-US-NP		
NAME OF SUBMITTER:		MAHIKA SINGH	MAHIKA SINGH	
SIGNATURE:		/MAHIKA SINGH/	/MAHIKA SINGH/	
DATE SIGNED:		07/19/2023	07/19/2023	
DATE SIGNED:		01/10/2020		

## ASSIGNMENT

WHEREAS, Molex Japan LLC, a limited liability company having a place of business at 5-4, Fukami Higashi 1-chome, Yamato City, Kanagawa Prefecture, Japan ("Assignor"), owns or owned an interest in certain new and useful inventions for "HIGHLY RELIABLE TERMINAL AND CONNECTOR WITH A COMPACT LOW PROFILE", for which a U.S. patent application ("Application") was filed on August 2, 2021, and accorded Application No. 17/391359 (Case Ref. No. MX-2020-PAT-0124-US-NP); and

WHEREAS, Molex, LLC, a limited liability company having a place of business at 2222 Wellington Court, Lisle, Illinois 60532 ("Assignee"), desires acquiring or has acquired Assignor's interest in the above-identified inventions, the Application, and any related U.S. or foreign patent applications and patents;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged:

Assignor hereby authorizes Assignee to file any of the above-referenced patent applications in the name of Assignee, and Assignor authorizes and requests the patent office of any country to issue any patent granted from any of the above-referenced patent applications in the name of Assignee;

Assignor by this Assignment does hereby sell, assign, and transfer, or by virtue of employment or applicable agreements has sold, assigned, and transferred, to Assignee, Assignor's entire right, title, and interest in and to the above-identified inventions and all improvements and modifications to the above-identified inventions, the Application, any U.S. or foreign patent applications related to the above-identified inventions, any U.S. or foreign patent applications claiming priority to any of the above-referenced patent applications, including any nonprovisional, divisional, continuation, continuation-in-part, reexamination, reissue, extension, substitution, or renewal of any of the above-referenced patent applications, any right to claim priority arising from or required for any of the above-referenced patent applications under any applicable convention, treaty, statute, or regulation, any other right, privilege, or form of protection related to the above-identified inventions or any of the above-referenced patent applications, and any U.S. or foreign patent granted from any of the above-referenced patent applications, to the full end of the term of the patent, to be held and enjoyed by Assignee as fully and entirely as it would have been held and enjoyed by Assignor, including the right to pursue, collect, and retain damages and any other remedies arising from any past, present, or future infringement of patents granted from the above-referenced patent applications;

Assignor hereby warrants and covenants that Assignor has not and will not execute any assignment or other instrument in conflict with this Assignment;

Assignor hereby covenants and agrees to perform any reasonable act that may be necessary or desirable to aid Assignee, its successors, legal representatives, and assigns, to obtain, maintain, and enforce protection in the U.S. and foreign countries for the above-identified inventions, above-referenced patent applications, and patents granted therefrom, including signing lawful papers, executing patent applications, making assignments, rightful oaths, and declarations, and testifying in judicial or administrative proceedings; and

Assignor and Assignee agree that this Assignment may be electronically signed, and that the electronic signatures appearing on this Assignment are the same as handwritten signatures for the purposes of validity, enforceability, and admissibility.

Case Ref. No. MX-2020-PAT-0124-US-NP

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Jae Hoon Lee, Authorized Signatory on behalf of Assignor: Molex Japan LLC Date: <u>20, 25 202.0</u>

## DECLARATION OF ACCEPTANCE

Assignee hereblancs how big and accepts the aforementioned assignment of right, title, and interest and confirms consent that this Assignment may be recorded in appropriate patent offices.

/\_\_\_\_\_ James A. O'Malley, Authorized Signatory on behalf of Assignee: Molex, LLC Date: <u>/0.///.2020</u>